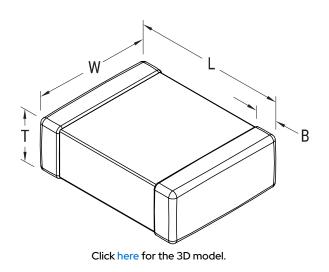




CBR-SMD RF COG, Ceramic, 8.9 pF, +/-0.1 pF, 200 VDC, COG, SMD, Fixed, RF, Ultra High Q, Low ESR, Class I, 0402



General Information	
Series	CBR-SMD RF COG
Style	SMD Chip
Description	SMD, Fixed, RF, Ultra High Q, Low ESR, Class I
Features	Ultra High Q, Low ESR, Class I
RoHS	Yes
Termination	Tin
Marking	No
AEC-Q200	No
Typical Component Weight	1.37 mg
Notes	Solder Reflow Only.
Shelf Life	78 Weeks
MSL	1

8.9 pF

Dimensions	
Chip Size	0402
L	1mm +/-0.05mm
W	0.5mm +/-0.05mm
Т	0.5mm +/-0.05mm
В	0.25mm +0.05/-0.1mm

L	1mm +/-0.05mm	Tolerance	+/-0.1 pF
W	0.5mm +/-0.05mm	Voltage DC	200 VDC
Т	0.5mm +/-0.05mm	Dielectric Withstanding Voltage	500 VDC
В	0.25mm +0.05/-0.1mm	Temperature Range	-55/+125°C
		Temp. Coefficient	COG
Packaging Specifications		Aging Rate	0% Loss/Decade Hour
Packaging	T&R, 180mm, Plastic Tape	Insulation Resistance	10 GOhms
Packaging Quantity 10000	Quality Factor	578	

Specifications Capacitance

Statements of suitability for certain applications are based on our knowledge of typical operating conditions for such applications, but are not intended to constitute - and
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